



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

2SC4482 — NPN Epitaxial Planar Silicon Transistor

High-Current Switching Applications

Features

- Low saturation voltage
- Large current capacity
- High-speed switching

Specifications

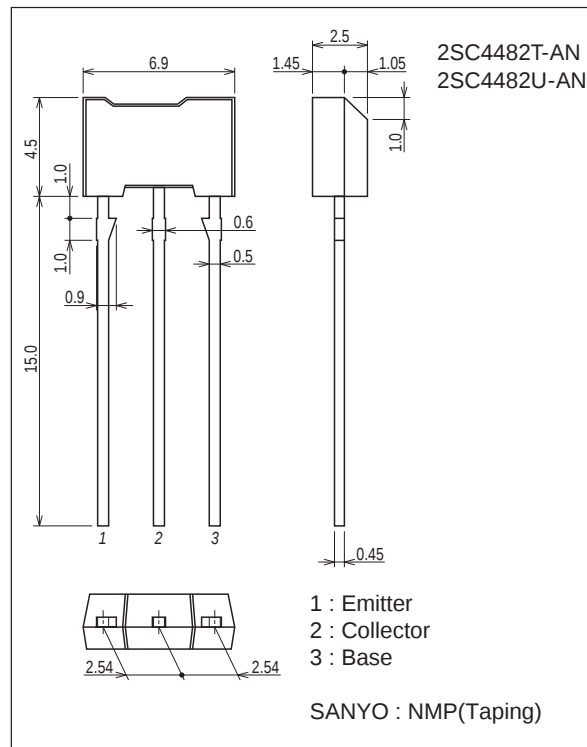
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		60	V
Collector-to-Emitter Voltage	VCEO		20	V
Emitter-to-Base Voltage	VEBO		6	V
Collector Current	IC		5	A
Collector Current (Pulse)	ICP		8	A
Collector Dissipation	PC		1	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ)

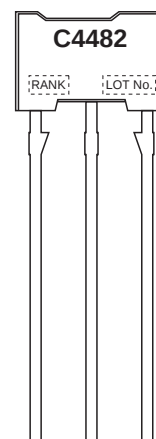
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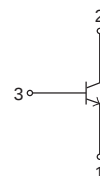
Product & Package Information

- Package : NMP(Taping)
- JEITA, JEDEC : SC-71
- Minimum Packing Quantity : 2,500 pcs./box

Marking(NMP(Taping))



Electrical Connection



SANYO Semiconductor Co., Ltd.

<http://www.sanyosemi.com/en/network/>

82912 TKIM TC-00002808/91604TN (PC)/D2598HA (KT)/O269MO, TS No.3235-1/6

2SC4482

Electrical Characteristics at $T_a=25^\circ\text{C}$

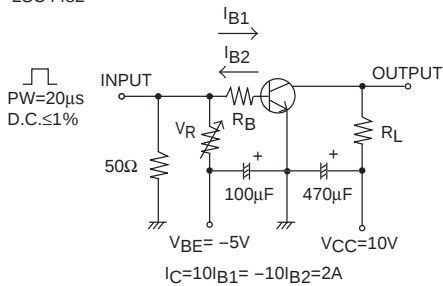
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=50\text{V}, I_E=0\text{A}$			100	nA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=5\text{V}, I_C=0\text{A}$			100	nA
DC Current Gain	h_{FE1}	$V_{CE}=2\text{V}, I_C=500\text{mA}$	200*		560*	
	h_{FE2}	$V_{CE}=2\text{V}, I_C=3\text{A}$	95			
Gain-Bandwidth Product	f_T	$V_{CE}=10\text{V}, I_C=50\text{mA}$		150		MHz
Output Capacitance	C_{ob}	$V_{CB}=10\text{V}, f=1\text{MHz}$		45		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=3\text{A}, I_B=60\text{mA}$		220	500	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=3\text{A}, I_B=60\text{mA}$			1.5	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=10\mu\text{A}, I_E=0\text{A}$	60			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=1\text{mA}, R_{BE}=\infty$	20			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=10\mu\text{A}, I_C=0\text{A}$	6			V
Turn-ON Time	t_{on}	See specified Test Circuit.		30		ns
Storage Time	t_{stg}			300		ns
Fall Time	t_f			40		ns

* : The 2SC4482 is classified by 500mA h_{FE} as follows :

Rank	T	U
h_{FE}	200 to 400	280 to 560

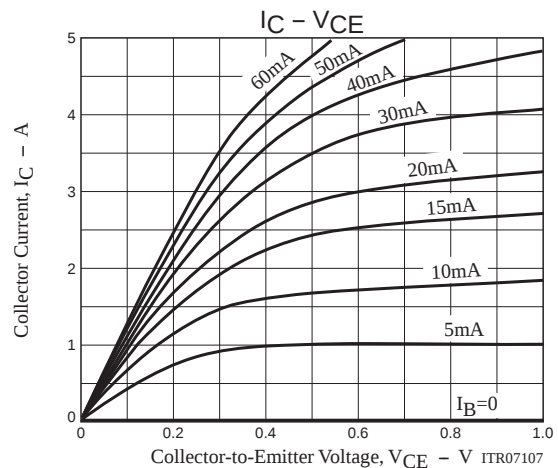
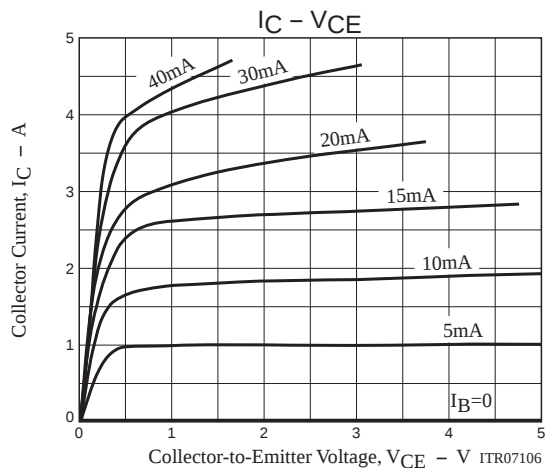
Switching Time Test Circuit

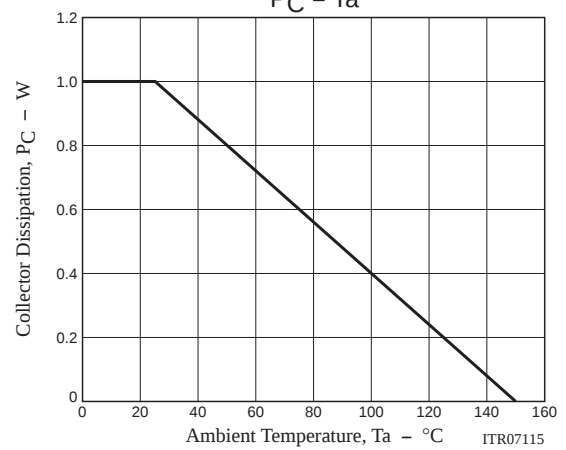
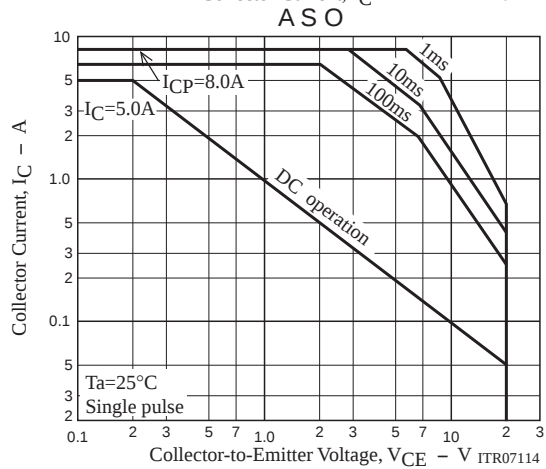
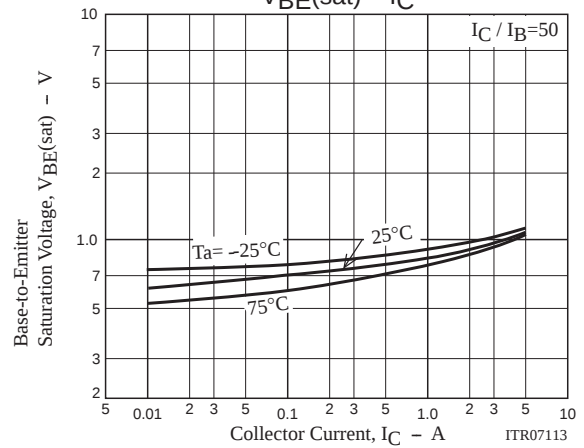
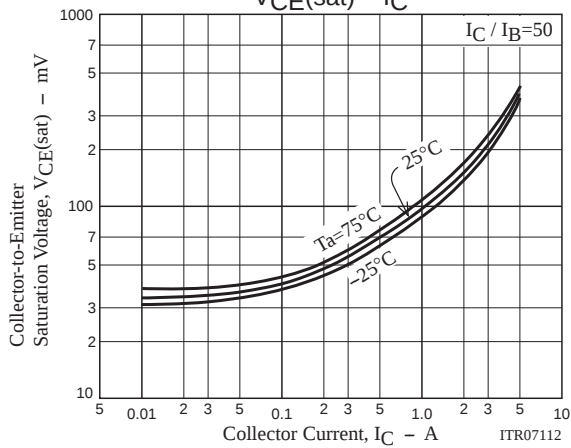
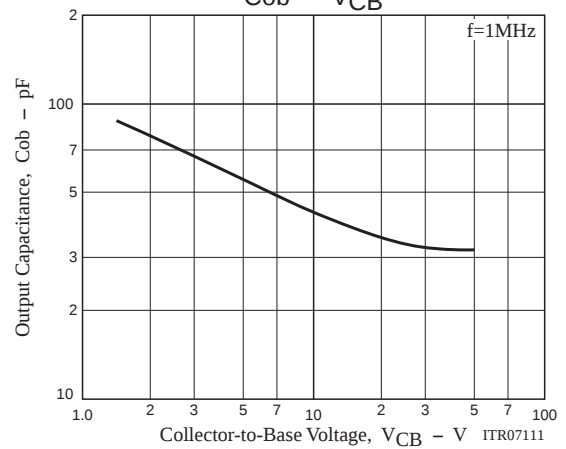
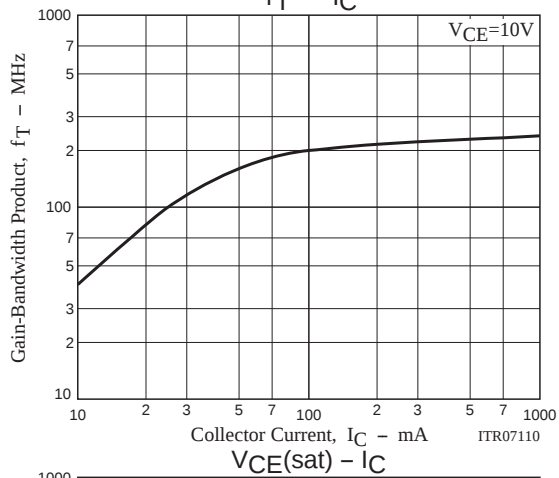
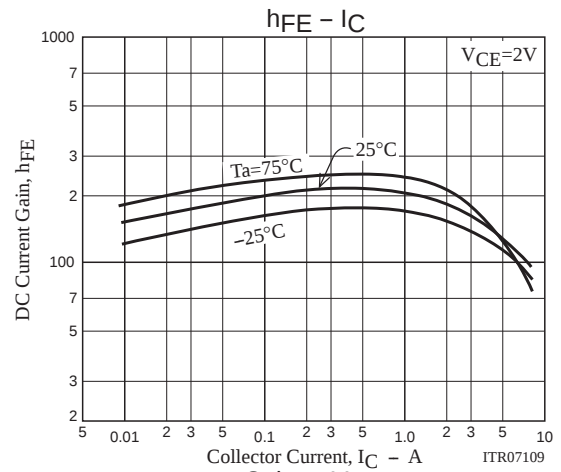
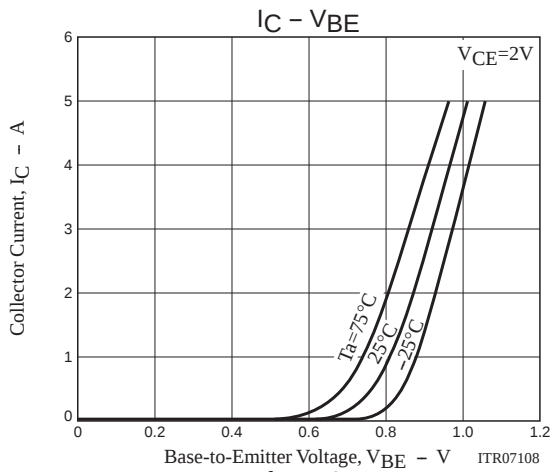
2SC4482



Ordering Information

Device	Package	Shipping	memo
2SC4482T-AN	NMP(Taping)	2,500pcs./box	Pb Free
2SC4482U-AN	NMP(Taping)	2,500pcs./box	





Bag Packing Specification

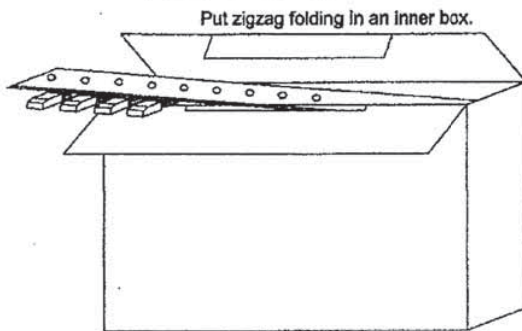
2SC4482T-AN, 2SC4482U-AN

NMP (Zigzag folding)

Storage package Outline name	Package type	Maximum Number of devices contained (pcs.)		Packing format	
		Inner box No.	Storage quantity	Outer box (C-6)	Outer box (C-8)
NMP	AN/AZ	C-3 Inner box Dimensions :mm(external) 330×45×125	2,500	8 inner boxes contained(20,000pcs.) Outer box Dimensions:mm(external) 585×345×195	4 inner boxes contained(10,000pcs.) Outer box Dimensions:mm(external) 345×300×195

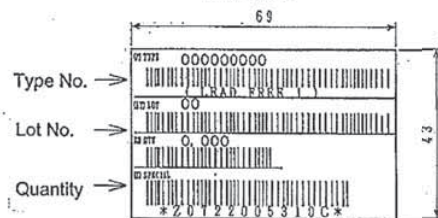
1. Packing format

Packing method



2. Bar code label

(Unit : mm)

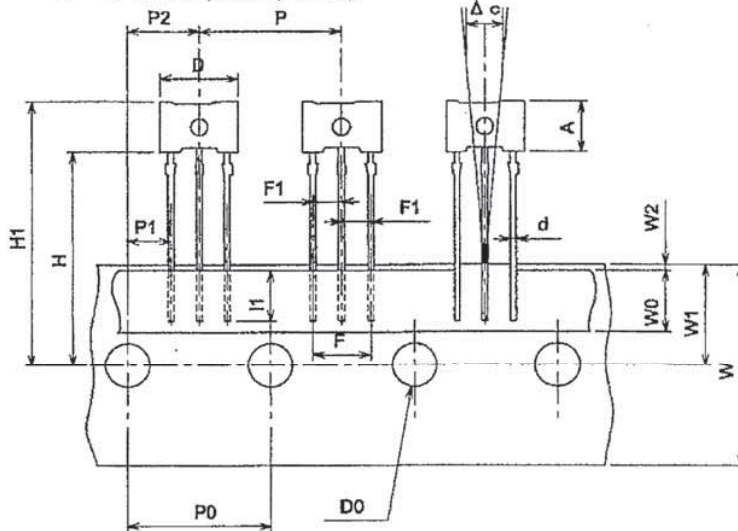


*LEAD FREE 1:

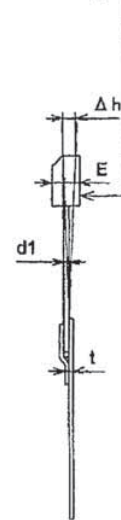
Lead-free External terminal surface treatment product.

2. Taping specifications

2-1. Carrier tape size (Unit:mm)



Marking surface



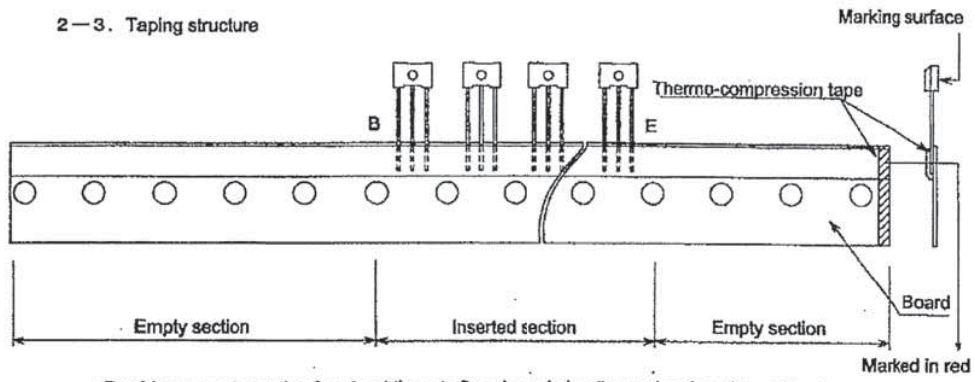
2-2. Taping size standard

Item	Symbol	Standard	Tolerance
Work piece outside diameter	D	6.9	±0.2
	E	2.5	±0.2
Work piece height	A	4.5	±0.2
Lead wire diameter	d	0.5	±0.1
Lead wire thickness	d1	0.45	±0.1
Bonded lead wire	I1	3.0MIN	
Pitch between products	P	12.7	±0.5
Pitch between perforations	P0	12.7	±0.2
Total pitch for 21 perforations	P0×20	254.0	±1.0
Distance between lead wire	F	5.0	+0.8 -0.2
Lead wire pitch distance	F1	2.54	+0.4 -0.1
Displacement of perforations	P1	3.81	±0.3
	P2	6.35	±0.3
Displacement of tape	W2	0~0.5	

Unit:mm

Item	Symbol	Standard	Tolerance
Tape width	W	18.0	±0.5
Adhesive tape	W0	6.0	±0.5
Displacement of perforations	W1	9.0	±0.5
Work piece bottom surface position	H	19.0	+1.0 -0.5
Work piece upper limit position	H1	23.5	±1.0
Perforations diameter	D0	φ4.0	±0.2
Tape thickness (total thickness)	t	0.6	±0.2
Product inclination	Δc	0	±0.7
Product inclination	Δh	0	±1.0

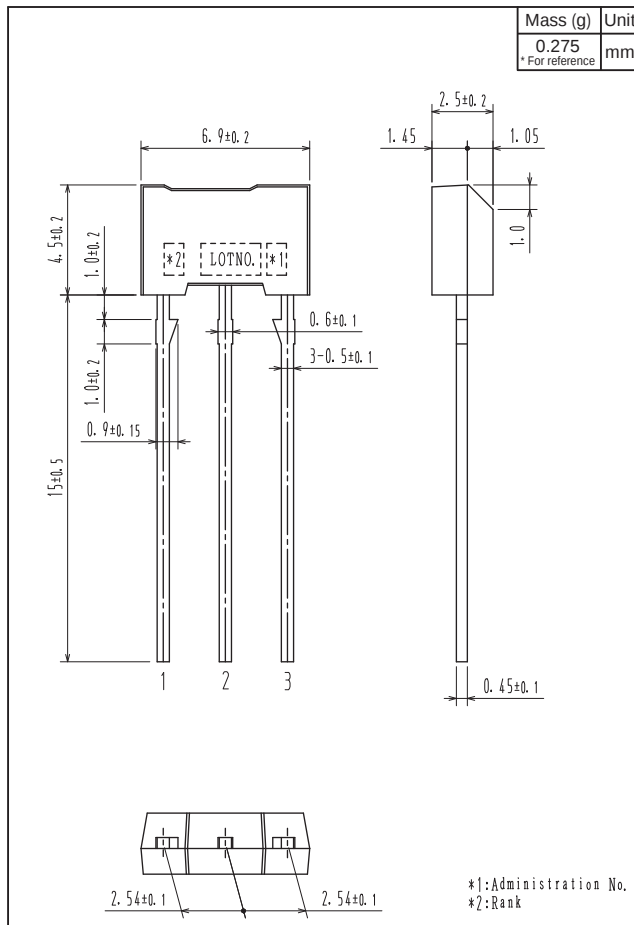
2—3. Taping structure



- Provide an empty section for about three to five pieces in leading and end portions of the tape.
- Provide an empty section in the fold-back portion.
- Provide marking in red to the E-side end of the board.

Outline Drawing

2SC4482T-AN, 2SC4482U-AN



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